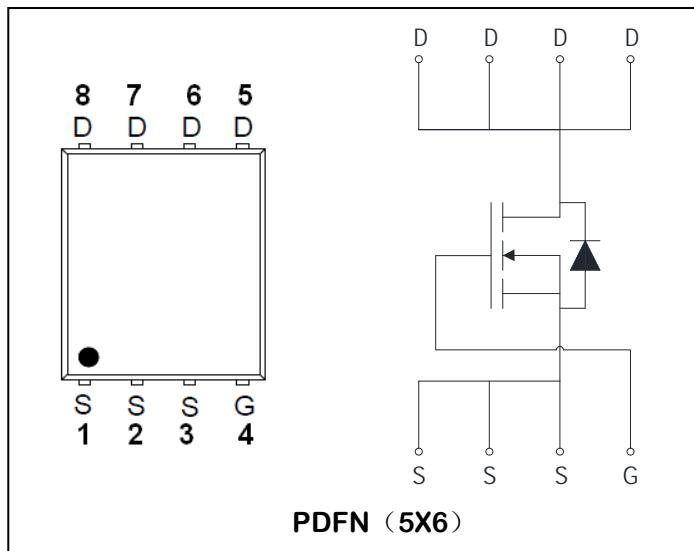


N-Channel Enhancement Mode Field Effect Transistor**PRODUCT SUMMARY**

V_{DSS}	I_D	$R_{DS(ON)}$ ($m\Omega$)
30V	60A	5m Ω

Features:

- Low Gate Charge for Fast Switching Application
- Low $R_{DS(ON)}$ to Minimize Conductive Loss
- 100% EAS Guaranteed
- Optimized $V_{(BR)DSS}$ Ruggedness
- Lead-Free, RoHS Compliant

**Description:**

The ADM60N03Q uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

Absolute Maximum Ratings ($T_A = 25^\circ C$ unless otherwise specified)

Symbol	Parameter	Ratings	Unit
Common Ratings			
V_{DSS}	Drain-Source Voltage	30	V
V_{GSS}	Gate-Source Voltage	± 20	
T_J	Maximum Junction Temperature	150	°C
T_{STG}	Storage Temperature Range	-55 to 150	°C
I_S	Diode Continuous Forward Current	60	A
Mounted on Large Heat Sink			
I_{DM}	300μs Pulse Drain Current Tested ⁽²⁾	$T_c = 25^\circ C$	240
I_D	Continuous Drain Current ⁽¹⁾	$T_c = 25^\circ C$	60
		$T_c = 100^\circ C$	39
P_D	Maximum Power Dissipation	$T_c = 25^\circ C$	31

Thermal Characteristics

Symbol	Parameter	Ratings	Unit
R_{thJC}	Thermal resistance junction-case max ⁽¹⁾	4	°C/W
R_{thJA}	Thermal resistance junction-ambient max ⁽¹⁾	38	°C/W

Electrical Characteristics (TA=25°C Unless Otherwise Noted)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
On/off Characteristics						
V _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _{DS} =250uA	30	--	--	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =30V, V _{GS} =0V , T _J =25°C	--	--	1	uA
V _{Gs(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _{DS} =250uA	1	1.5	2.5	V
I _{GSS}	Gate Leakage Current	V _{GS} =±20V, V _{DS} =0V	--	--	±100	nA
R _{Ds(ON)}	Drain-SourceOn-stateResistance ⁽²⁾	V _{GS} = 10V, I _{DS} =45A	--	3.8	5	mΩ
		V _{GS} = 4.5V, I _{DS} =45A	--	7.5	11	
Dynamic Characteristics						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =15V, Frequency=1MHz	--	2100	--	pF
C _{oss}	Output Capacitance		--	326	--	
C _{rss}	Reverse Transfer Capacitance		--	282	--	
Switching Characteristics						
t _{d(ON)}	Turn-on Delay Time	V _{DS} =15V, I _D = 30A, V _{GS} = 10V, R _{GEN} =3 Ω	--	21	--	nS
t _r	Turn-on Rise Time		--	32	--	
t _{d(OFF)}	Turn-off Delay Time		--	59	--	
t _f	Turn-off Fall Time		--	34	--	
Q _g	Total Gate Charge	V _{DS} =15V, V _{GS} = 10V, I _{DS} =30A	--	45	--	nC
Q _{gs}	Gate-Source Charge		--	3	--	
Q _{gd}	Gate-Drain Charge		--	15	--	
Avalanche Characteristics						
EAS	Single Pulse Avalanche Energy ⁽³⁾	L=0.5mH	85	--	--	mJ
Diode Characteristics						
V _{SD}	Diode Forward Voltage ⁽²⁾	I _{SD} = 45A, V _{GS} = 0	--	--	1.2	V
t _{rr}	Reverse Recovery Time	I _{SD} =90A, dI _{SD} /dt=100A/μs	--	48	--	ns
q _{rr}	Reverse Recovery Charge		--	60	--	nC

NOTES:

1. Surface Mounted on FR4 Board, t ≤ 10 sec.

2.The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%

3.The Min. value is 100% EAS tested guarantee. Limited by TJmax, IAS =18.4A, VDD = 15V, RG = 25Ω, Starting TJ = 25°C.

Typical Performance Characteristics

Figure 1: On-Region Characteristics

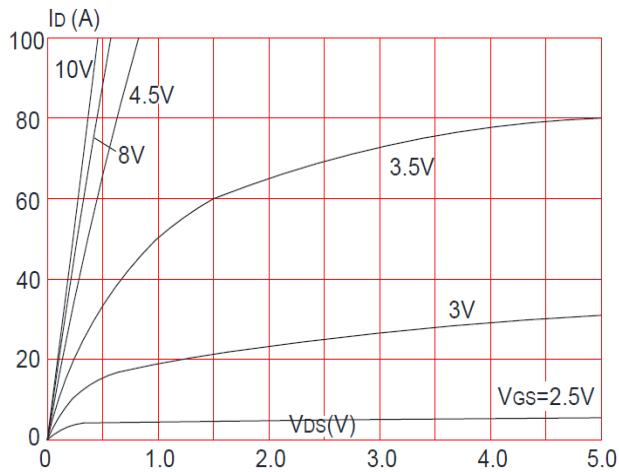


Figure 2: Typical Transfer Characteristics

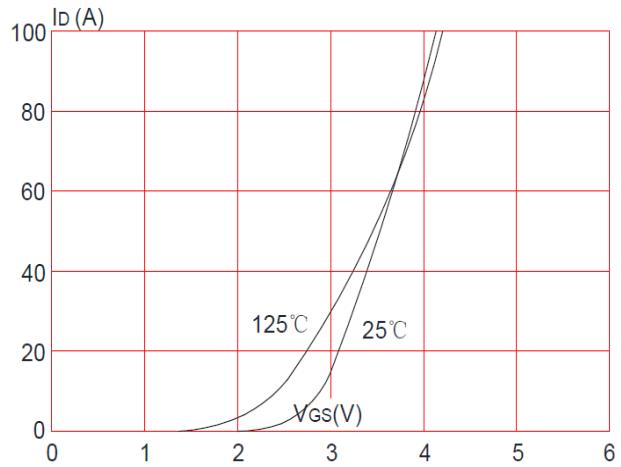


Figure 3: Forward Characteristics of Reverse

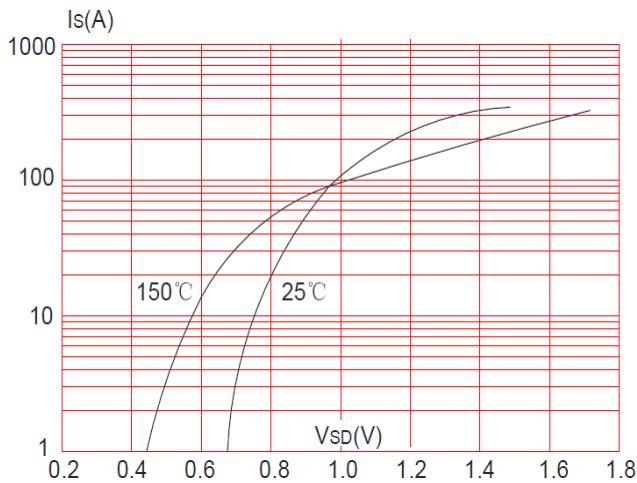


Figure 4: Normalized Breakdown Voltage vs. Junction Temperature

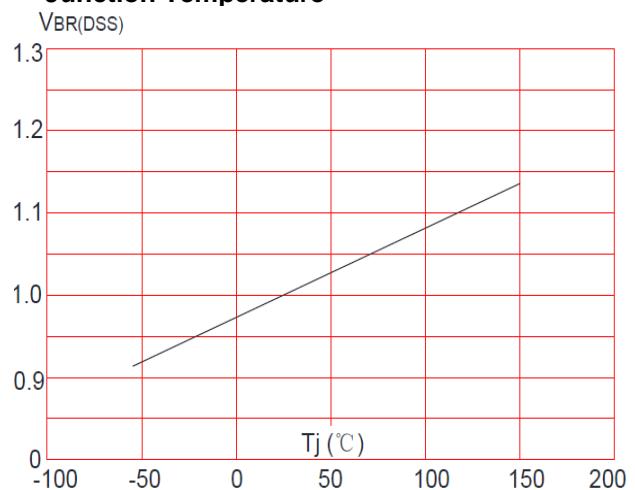


Figure 5: Normalized $R_{DS(on)}$ vs. T_j

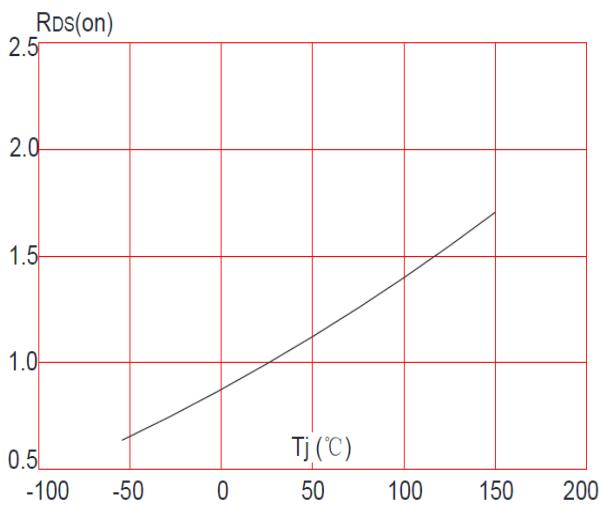


Figure 6: Gate Charge Characteristics

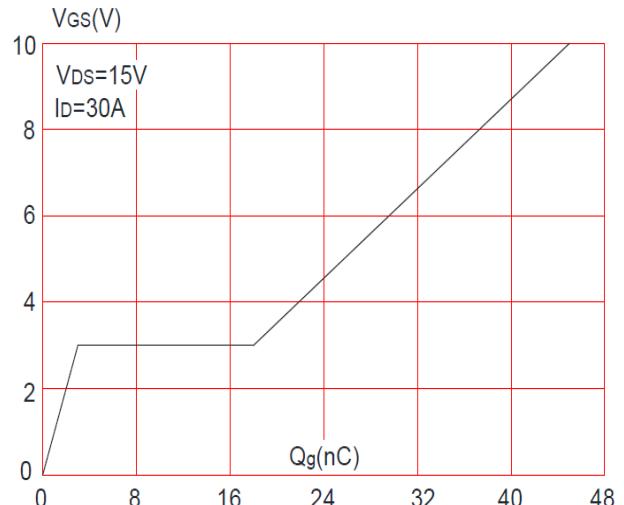
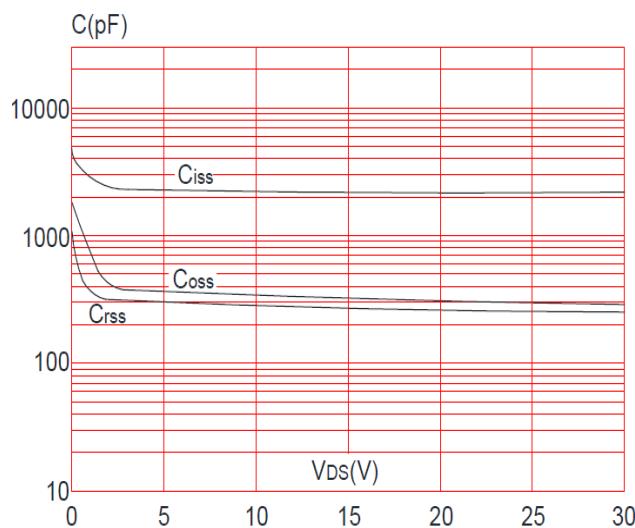
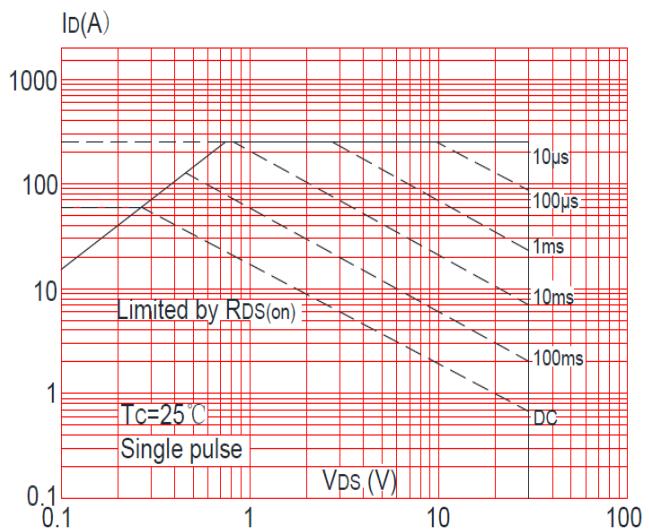
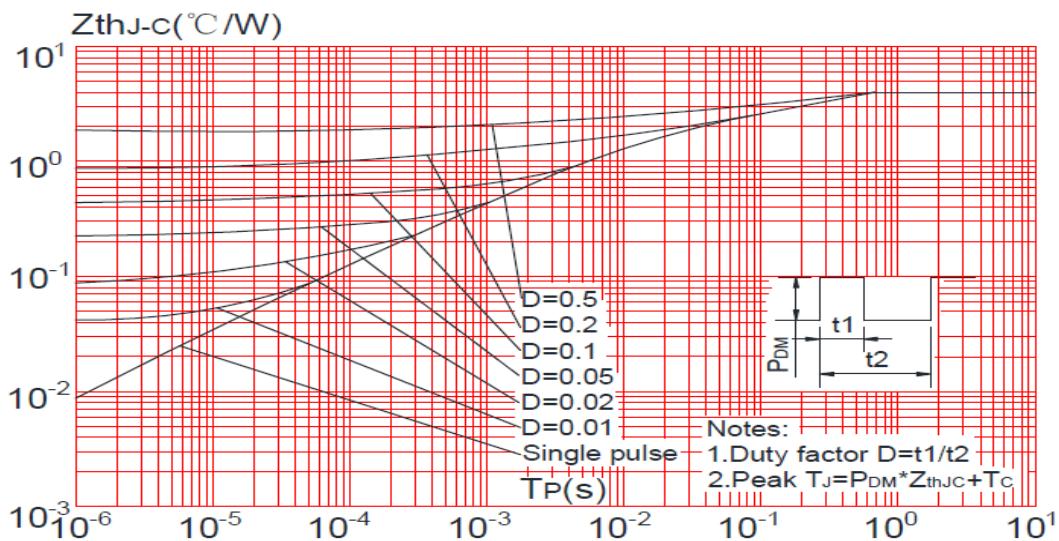
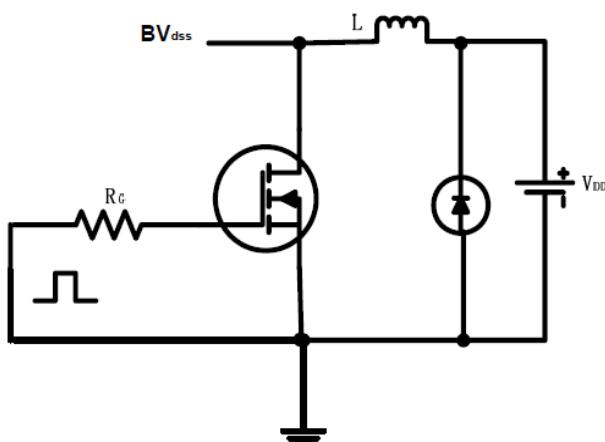


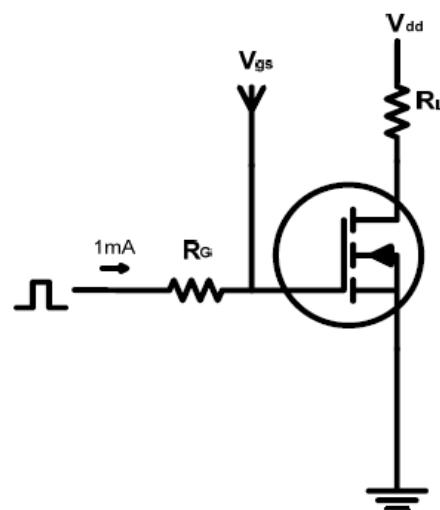
Figure 7: Capacitance**Figure 8: Safe Operating Area****Figure 9: Maximum Effective Transient Thermal Impedance, Junction-to-Case**

Test circuits and Waveforms

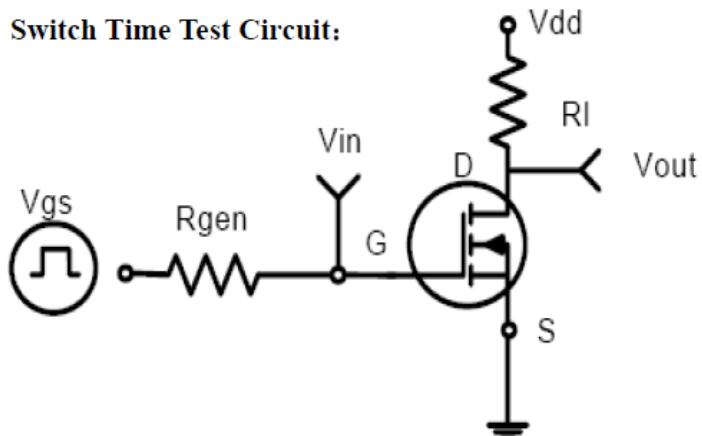
EAS test circuits:



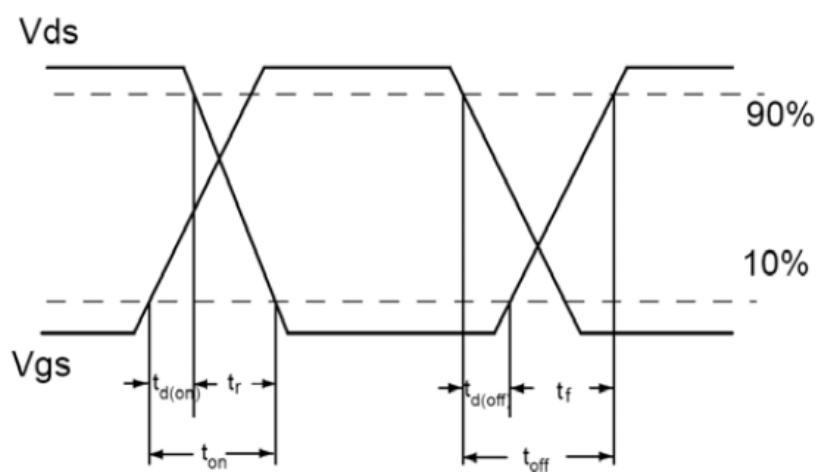
Gate charge test circuit:



Switch Time Test Circuit:

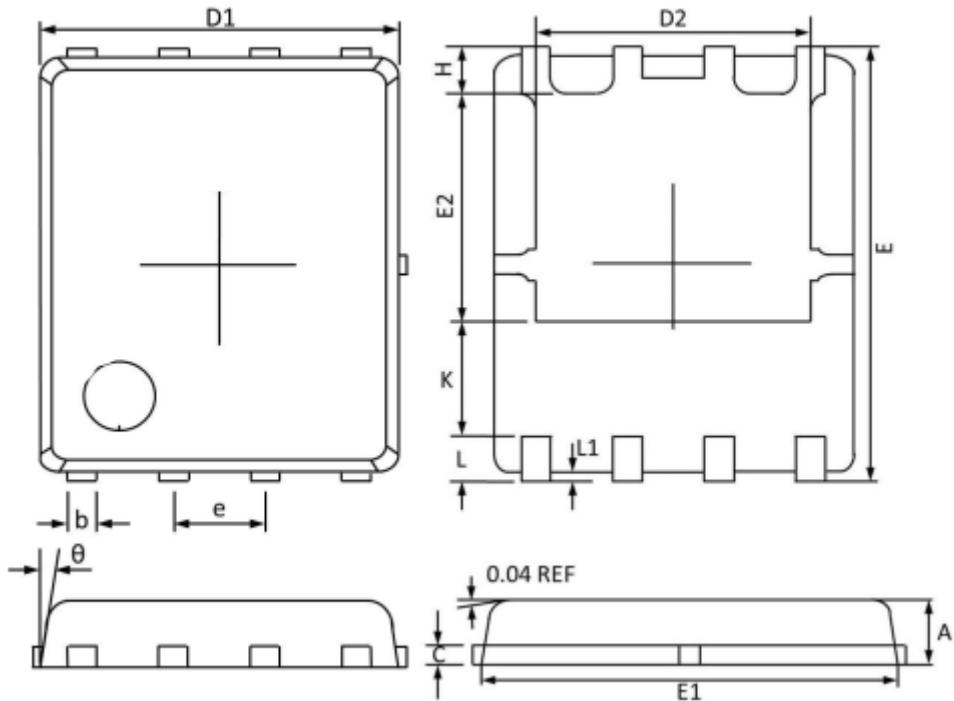


Switch Waveforms:



PACKAGE MECHANICAL DATA

PDFN (5X6) Package Dimension



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.800	1.100	0.031	0.043
b	0.330	0.510	0.013	0.020
c	0.200	0.300	0.008	0.012
D1	4.800	5.100	0.189	0.201
D2	3.610	4.100	0.142	0.161
E	5.900	6.200	0.232	0.244
E1	5.700	5.900	0.224	0.232
E2	3.350	3.780	0.132	0.149
H	0.410	0.700	0.016	0.028
K	1.100	1.500	0.043	0.059
e	1.270 TYP.		0.050 TYP.	
L	0.510	0.710	0.020	0.028
L1	0.060	0.200	0.002	0.008
θ	0°	12°	0°	12°